

# 6MBI180VX-120-50

**IGBT Modules** 

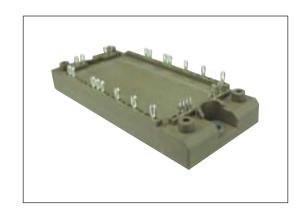
# IGBT MODULE (V series) 1200V / 180A / 6 in one package

#### **■** Features

Compact Package P.C.Board Mount Low Vce (sat)

#### Applications

Inverter for Motor Drive
AC and DC Servo Drive Amplifier
Uninterruptible Power Supply
Industrial machines, such as welding machines



## ■ Maximum Ratings and Characteristics

#### ● Absolute Maximum Ratings (at Tc=25°C unless otherwise specified)

Items		Symbols	Conditions		Maximum ratings	Units	
Collector-Emit	Collector-Emitter voltage				1200	V	
Gate-Emitter v	oltage	V <sub>GES</sub>				V	
- a	Collector current		Continuous	Tc=80°C	150		
Collector curre			1ms	Tc=80°C	400	^	
E Collector curr					150	Α	
			1ms		400		
Collector power	Collector power dissipation		1 device		835	W	
Junction temperature		Tj			175		
Operating junciton temperature (under switching conditions)		Tjop			150	°C	
Case temperature		Tc			125		
Storage temperature		Tstg			-40 to +125		
solation voltage	between terminal and copper base (*1) between thermistor and others (*2)	V <sub>iso</sub>	AC : 1min.		2500	VAC	
Screw torque	Mounting (*3)	-	M5		3.5	N m	

Note \*1: All terminals should be connected together during the test.

Note \*2: Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test.

Note \*3: Recommendable value : 2.5-3.5 Nm (M5)

#### ● Electrical characteristics (at Tj= 25°C unless otherwise specified)

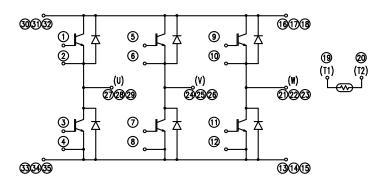
Items		Symbols	Conditions		Characteristics			Units
		Syllibols			min.	typ.	max.	Ullits
	Zero gate voltage collector current	Ices	V <sub>GE</sub> = 0V, V <sub>CE</sub> = 1200V		-	-	1.0	mA
	Gate-Emitter leakage current	Iges	$V_{GE} = 0V$ , $V_{GE} = \pm 20V$		-	-	200	nA
Inverter	Gate-Emitter threshold voltage	V <sub>GE (th)</sub>	V <sub>CE</sub> = 20V, I <sub>C</sub> = 200mA		6.0	6.5	7.0	V
	Collector-Emitter saturation voltage	.,	V <sub>GE</sub> = 15V I <sub>C</sub> = 200A	Tj=25°C	-	2.85	3.30	V
		(terminal)		Tj=125°C	-	3.20	-	
		(terrilinal)		Tj=150°C	-	3.25	-	
		.,	V <sub>GE</sub> = 15V I <sub>C</sub> = 200A	Tj=25°C	-	1.85	2.30	
		V <sub>CE (sat)</sub> (chip)		Tj=125°C	-	2.20	-	
		(Criip)		Tj=150°C	-	2.25	-	
	Input capacitance	Cies	V <sub>CE</sub> = 10V, V <sub>GE</sub> = 0V, f = 1MHz		-	16.5	-	nF
	Turn-on time	ton		-	0.39	1.20	μs	
		tr	$V_{CC} = 600V$ $I_{C} = 200A$ $V_{GE} = +15 / -15V$ $R_{G} = 1.2\Omega$		-	0.09		0.60
		tr (i)			-	0.03		-
		toff			-	0.53		1.00
	Turn-off time	tf			-	0.06		0.30
	Forward on voltage	V <sub>F</sub> (terminal)	I <sub>F</sub> = 200A	Tj=25°C	-	2.70	3.15	V
				Tj=125°C	-	2.85	-	
				Tj=150°C	-	2.80	-	
			I <sub>F</sub> = 200A	Tj=25°C	-	1.70	2.15	
		V <sub>F</sub>		Tj=125°C	-	1.85	-	
		(chip)		Tj=150°C	-	1.80	-	
	Reverse recovery time	trr	I <sub>F</sub> = ±20		-	-	0.1	μs
'n		R	T = 25°C		-	5000	-	Ω
	Resistance		T = 100°C		465	495	520	
The	B value	В	T = 25 / 50°C		3305	3375	3450	K

#### ● Thermal resistance characteristics

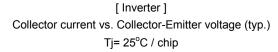
Items	Symbols	Conditions	Characteristics			Units
items		Conditions	min.	typ.	max.	Ullits
Thermal registeres (4 device)	Rth(j-c)	Inverter IGBT	-	-	0.18	°C/W
Thermal resistance (1device)		Inverter FWD	-	-	0.29	
Contact thermal resistance (1device) (*4)	Rth(c-f)	with Thermal Compound	-	0.05	-	

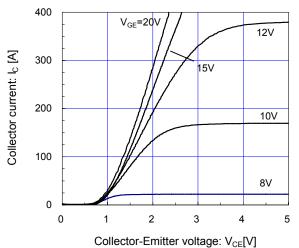
Note \*4: This is the value which is defined mounting on the additional cooling fin with thermal compound.

## **■** Equivalent Circuit Schematic

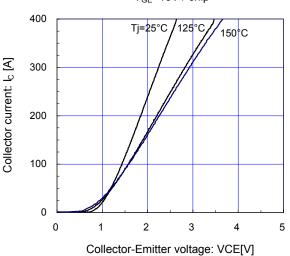


#### ■ Characteristics (Representative)

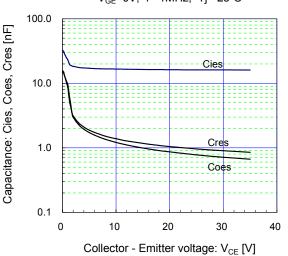


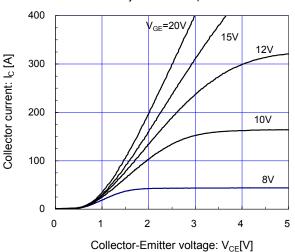


 $[Inverter\ ] \\ Collector\ current\ vs.\ Collector-Emitter\ voltage\ (typ.) \\ V_{GE} = 15V\ /\ chip$ 

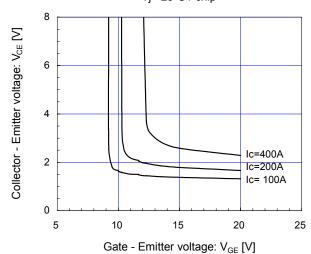


 $\label{eq:continuous} \begin{tabular}{ll} [Inverter] \\ Capacitance vs. Collector-Emitter voltage (typ.) \\ $V_{GE}$=0V, f= 1MHz, Tj= 25°C \\ \end{tabular}$ 





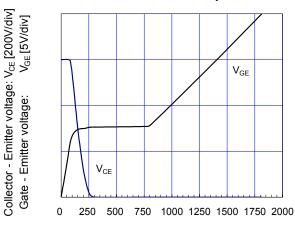
[ Inverter ] Collector-Emitter voltage vs. Gate-Emitter voltage (typ.)  $Tj = 25^{\circ}C \text{ / chip}$ 



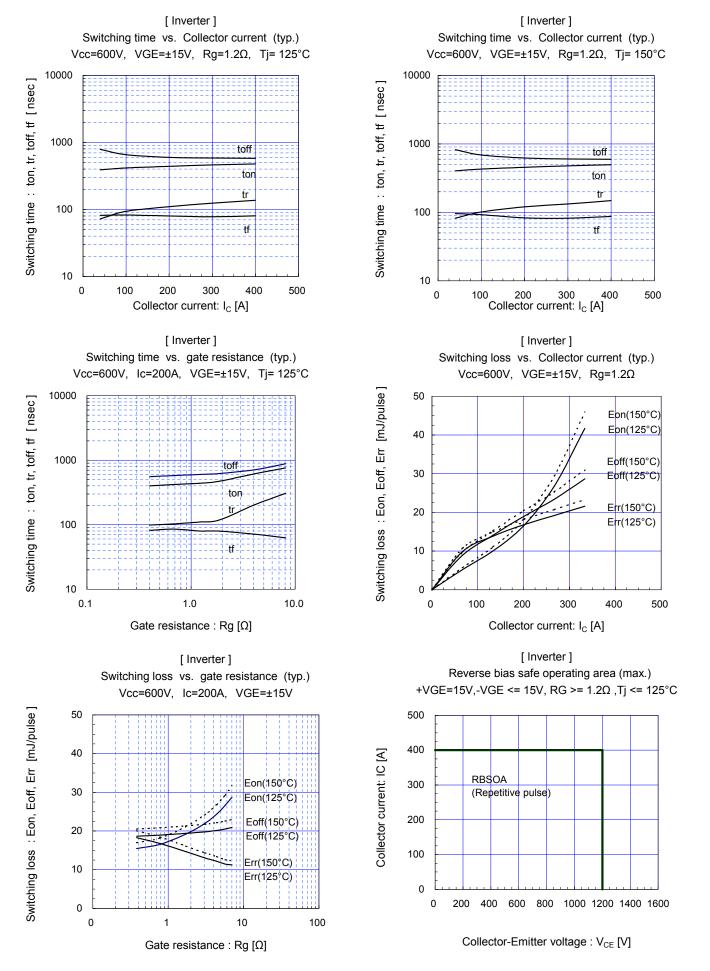
[ Inverter ]

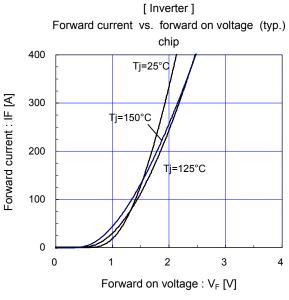
Dynamic gate charge (typ.)

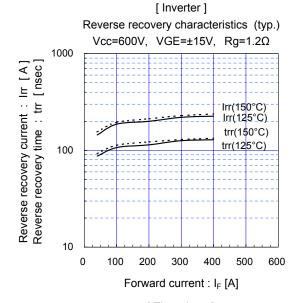
Vcc=600V, Ic=200A, Tj= 25°C

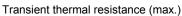


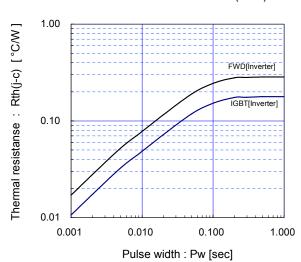
Gate charge: Qg [nC]

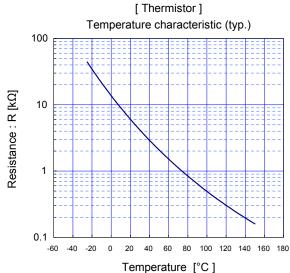




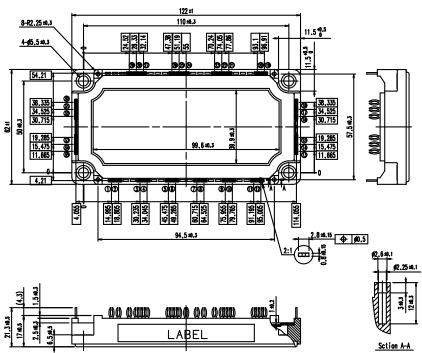








■ Outline Drawings, mm



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